



# ES2DP

200 V, 2 A hyperfast PN-rectifier

25 August 2017

Product data sheet

## 1. General description

High power density, hyperfast PN-rectifier with high-efficiency planar technology, encapsulated in a small and flat lead CFP5 (SOD128) Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Reverse voltage  $V_R \leq 200$  V
- Forward current  $I_F \leq 2$  A
- Hyperfast recovery time  $t_{rr} \leq 25$  ns
- Pt doped life time control
- Low inductance
- Small and flat lead SMD plastic package
- Package height typ. 1 mm
- High power capability due to clip-bond technology
- Capable for reflow and wave soldering
- Planar die design

## 3. Applications

- General-purpose rectification
- Reverse polarity protection
- Hyperfast switching
- Freewheeling applications

## 4. Quick reference data


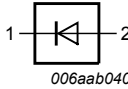
Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20$ kHz; square wave; $T_{sp} \leq 130$ °C		-	-	2	A
$V_{RRM}$	repetitive peak reverse voltage	$T_j = 25$ °C		-	-	200	V
$V_R$	reverse voltage			-	-	200	V
$V_F$	forward voltage	$I_F = 2$ A; pulsed; $T_j = 25$ °C	[1]	-	890	950	mV
		$I_F = 2$ A; pulsed; $T_j = 125$ °C	[1]	-	750	825	mV
$I_R$	reverse current	$V_R = 200$ V; pulsed; $T_j = 25$ °C	[1]	-	5	200	nA
		$V_R = 200$ V; pulsed; $T_j = 125$ °C	[1]	-	1.5	20	$\mu$ A

[1] Very short pulse, in order to maintain a stable junction temperature.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 CFP5 (SOD128)	 006aab040
2	A	anode		

## 6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
ES2DP	CFP5	plastic, surface mounted package; 2 terminals; 4 mm pitch; 3.8 mm x 2.6 mm x 1 mm body	SOD128

## 7. Marking

Table 4. Marking codes

Type number	Marking code
ES2DP	DN

## 8. Limiting values

**Table 5. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_{RRM}$	repetitive peak reverse voltage	$T_j = 25\text{ °C}$		-	200	V
$V_R$	reverse voltage			-	200	V
$V_{RMS}$	RMS voltage			-	140	V
$I_F$	forward current	$\delta = 1$ ; $T_{sp} \leq 125\text{ °C}$		-	2.8	A
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20\text{ kHz}$ ; square wave; $T_{sp} \leq 130\text{ °C}$		-	2	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 8.3\text{ ms}$ ; $T_{j(\text{init})} = 25\text{ °C}$ ; single half sine wave (applied at rated load condition)		-	46	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	835	mW
			[2]	-	1.316	W
$T_j$	junction temperature			-	150	°C
$T_{amb}$	ambient temperature			-55	150	°C
$T_{stg}$	storage temperature			-65	150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode  $1\text{ cm}^2$ .

## 9. Thermal characteristics

**Table 6. Thermal characteristics**

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	150	K/W
			[2]	-	-	95	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	10	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode  $1\text{ cm}^2$ .

[3] Soldering point of cathode tab.

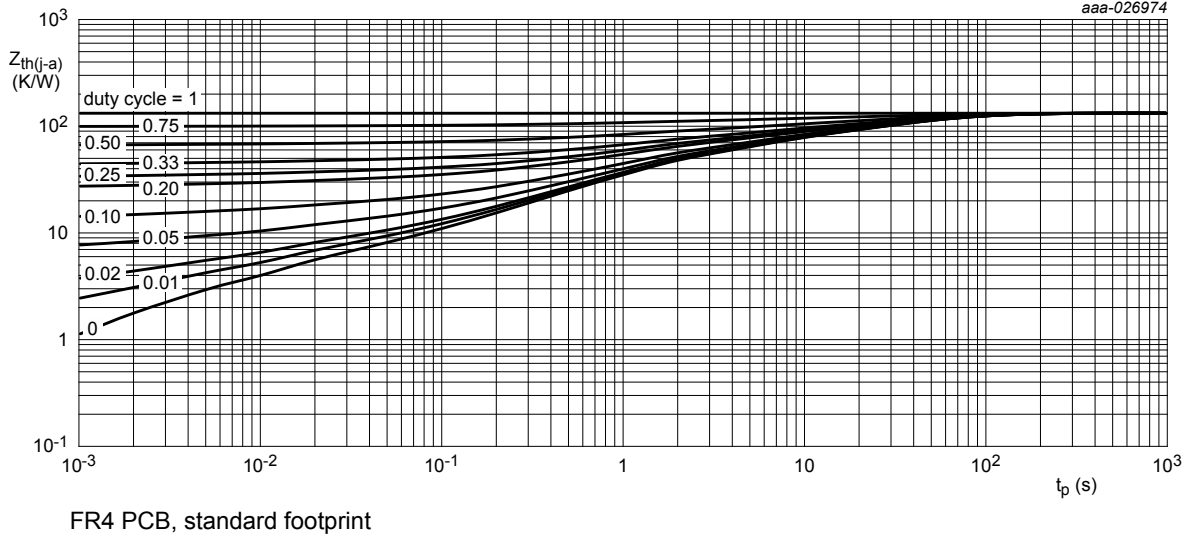


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

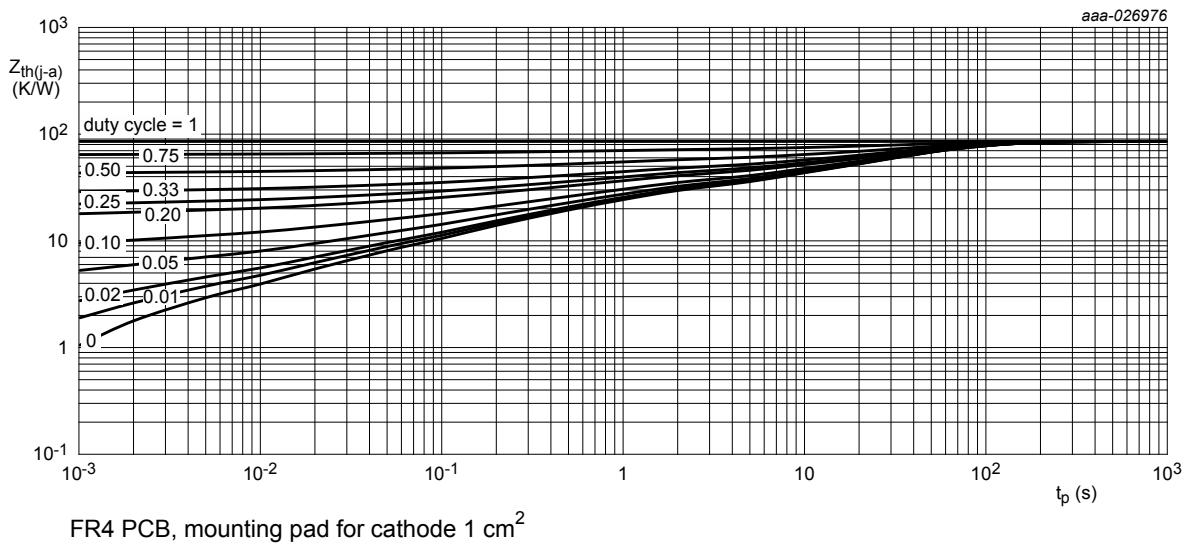


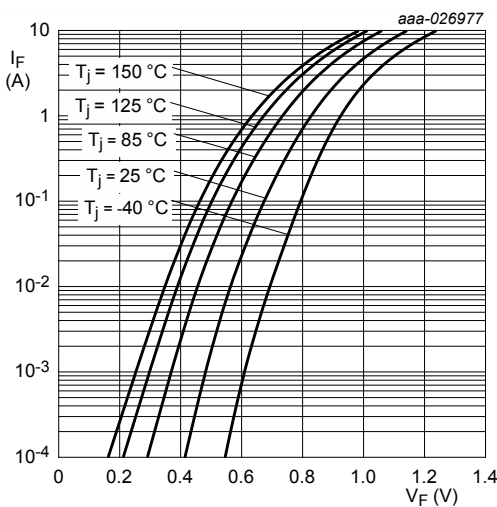
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

Table 7. Characteristics

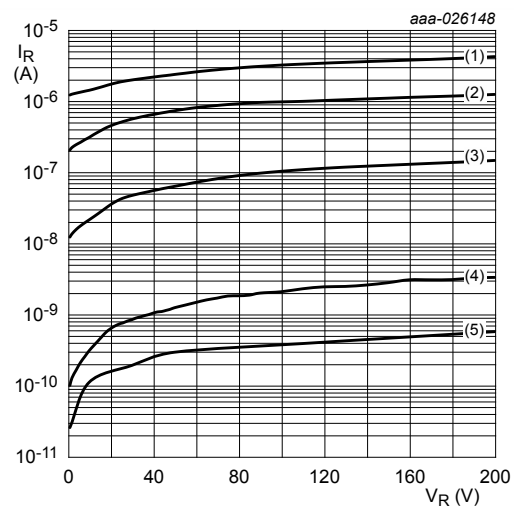
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 100 \mu\text{A}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$	[1]	200	-	-	V
$V_F$	forward voltage	$I_F = 2 \text{ A}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$	[1]	-	890	950	mV
		$I_F = 2 \text{ A}$ ; pulsed; $T_j = 125 \text{ }^\circ\text{C}$	[1]	-	750	825	mV
$I_R$	reverse current	$V_R = 200 \text{ V}$ ; pulsed; $T_j = 25 \text{ }^\circ\text{C}$	[1]	-	5	200	nA
		$V_R = 200 \text{ V}$ ; pulsed; $T_j = 125 \text{ }^\circ\text{C}$	[1]	-	1.5	20	$\mu\text{A}$
$C_d$	diode capacitance	$V_R = 4 \text{ V}$ ; $f = 1 \text{ MHz}$ ; $T_j = 25 \text{ }^\circ\text{C}$		-	20	-	pF
$t_{rr}$	reverse recovery time ; step recovery	$I_F = 0.5 \text{ A}$ ; $I_R = 1 \text{ A}$ ; $I_{R(\text{meas})} = 0.25 \text{ A}$ ; $T_j = 25 \text{ }^\circ\text{C}$		-	10	25	ns
	reverse recovery time ; ramp recovery	$I_F = 1 \text{ A}$ ; $dI_F/dt = 50 \text{ A}/\mu\text{s}$ ; $V_R = 30 \text{ V}$ ; $T_j = 25 \text{ }^\circ\text{C}$		-	20	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 1 \text{ A}$ ; $dI_F/dt = 50 \text{ A}/\mu\text{s}$ ; $T_j = 25 \text{ }^\circ\text{C}$		-	930	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.



pulsed condition

Fig. 3. Forward current as a function of forward voltage; typical values



pulsed condition

- (1)  $T_j = 150 \text{ }^\circ\text{C}$
- (2)  $T_j = 125 \text{ }^\circ\text{C}$
- (3)  $T_j = 85 \text{ }^\circ\text{C}$
- (4)  $T_j = 25 \text{ }^\circ\text{C}$
- (5)  $T_j = -40 \text{ }^\circ\text{C}$

Fig. 4. Reverse current as a function of reverse voltage; typical values

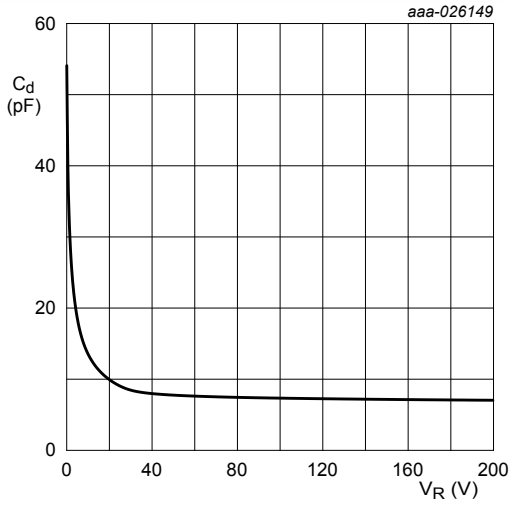


Fig. 5. Diode capacitance as a function of reverse voltage; typical values

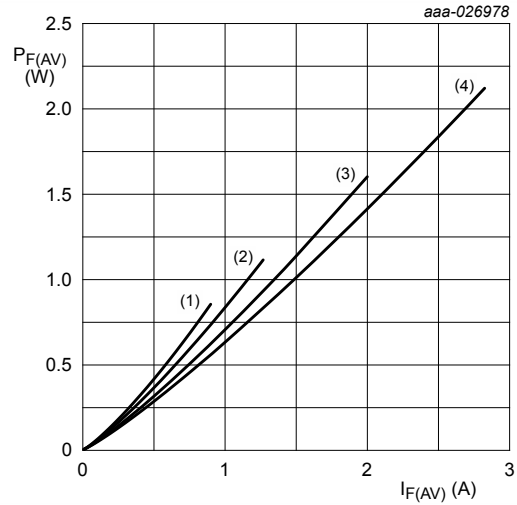


Fig. 6. Average forward power dissipation as a function of average forward current; typical values

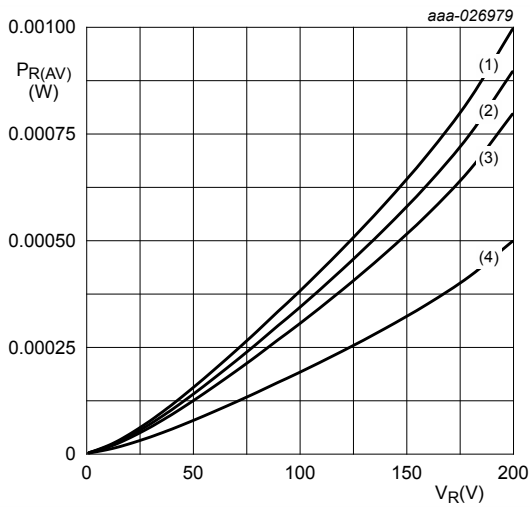


Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values

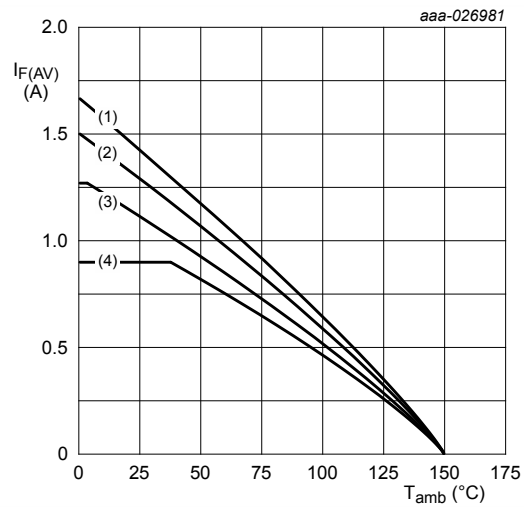


Fig. 8. Average forward current as a function of ambient temperature; typical values

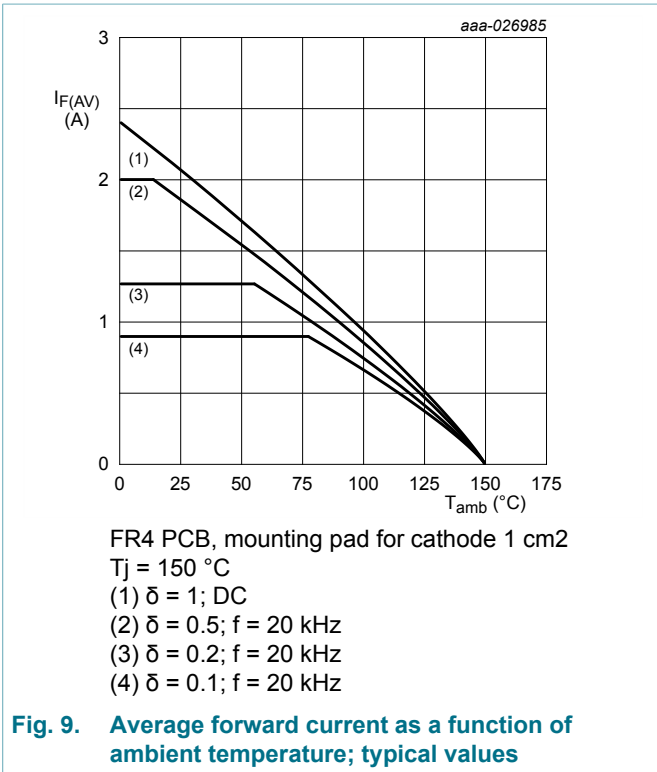


Fig. 9. Average forward current as a function of ambient temperature; typical values

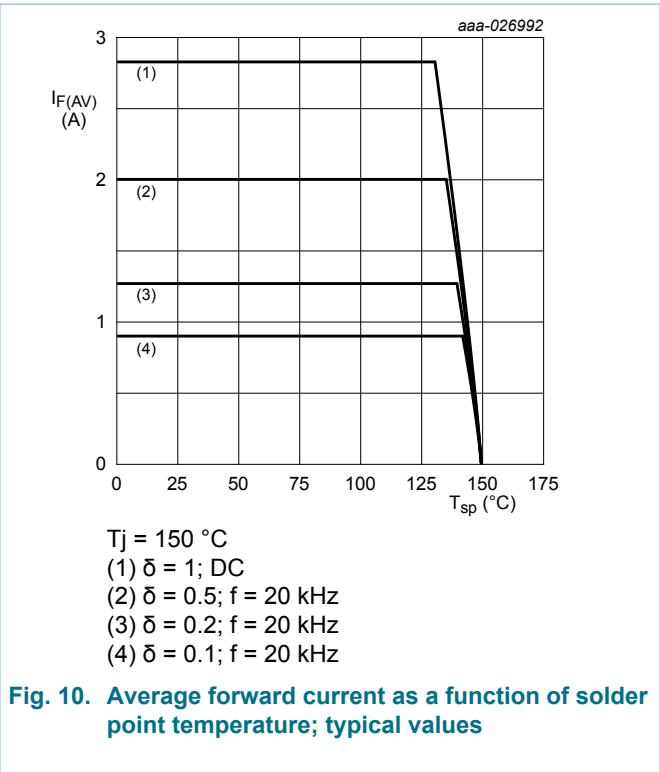


Fig. 10. Average forward current as a function of solder point temperature; typical values

## 11. Test information

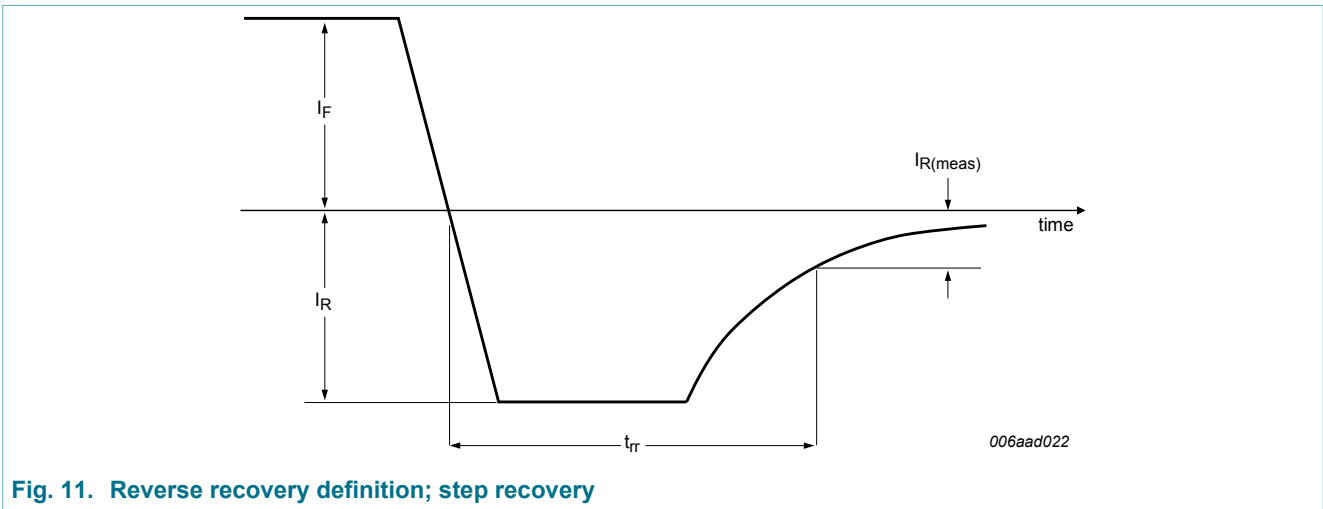


Fig. 11. Reverse recovery definition; step recovery

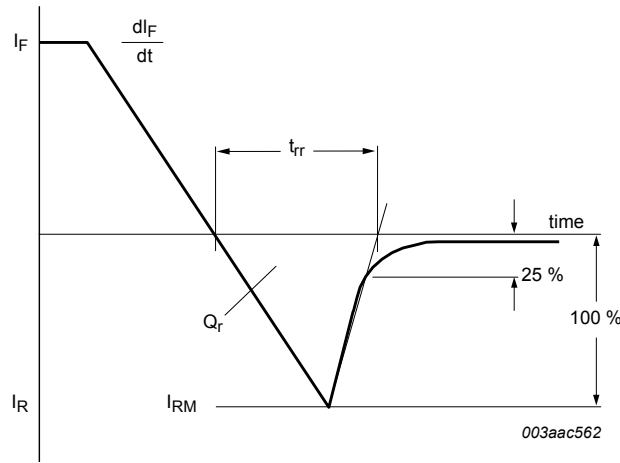


Fig. 12. Reverse recovery definition; ramp recovery

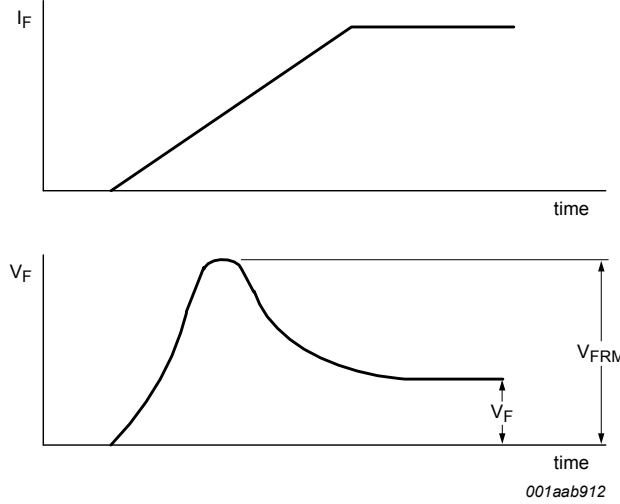


Fig. 13. Forward recovery definition

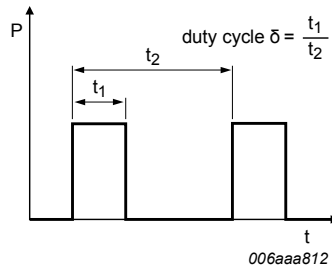


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.



## 12. Package outline

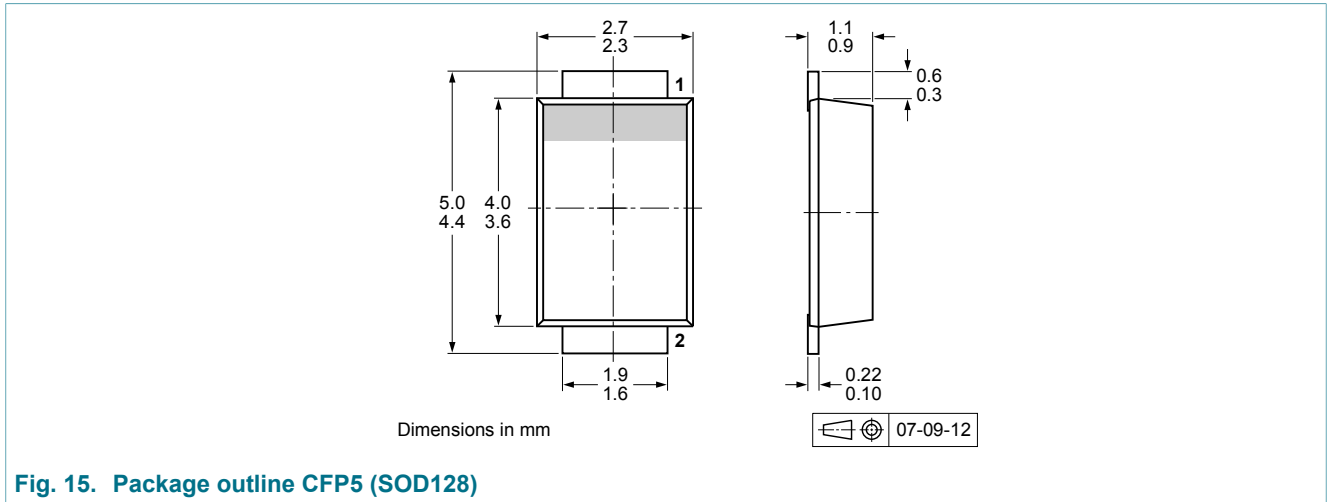


Fig. 15. Package outline CFP5 (SOD128)

## 13. Soldering

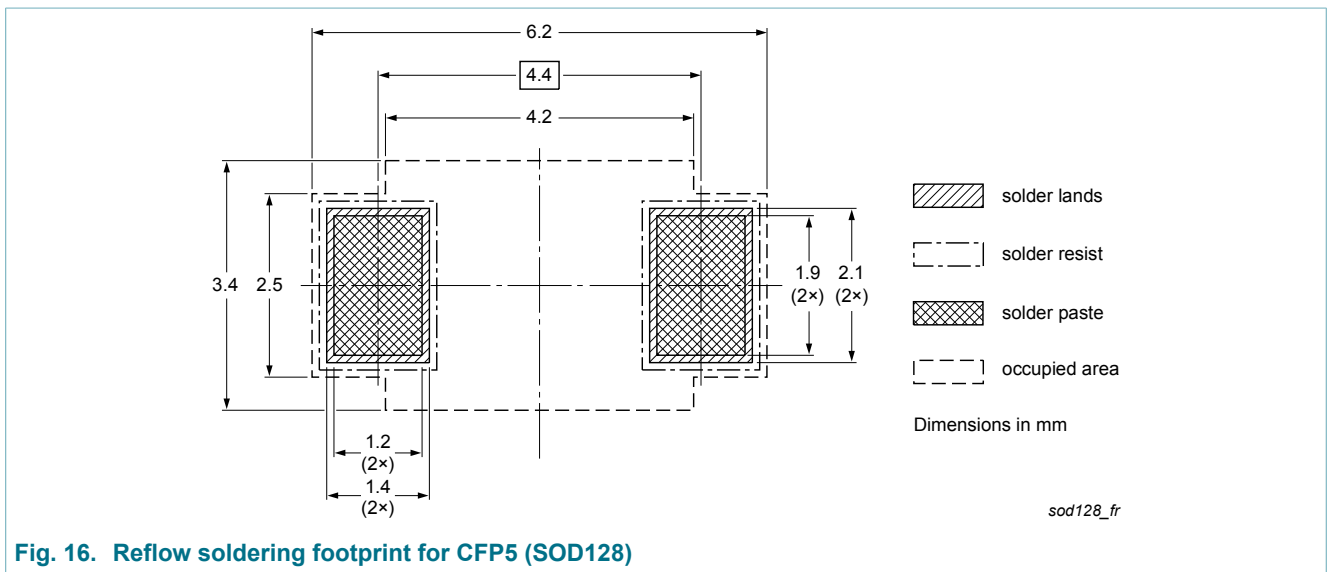
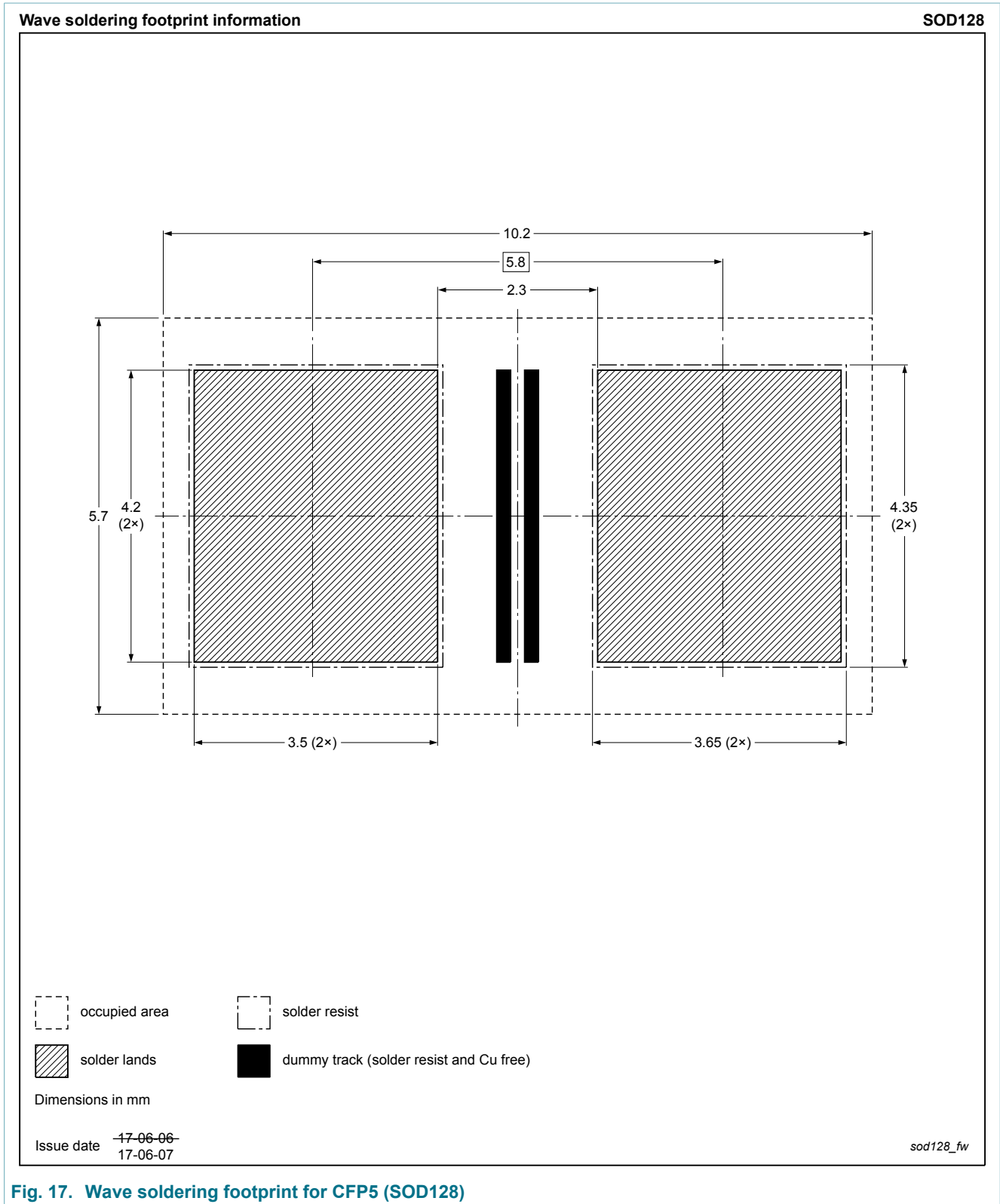


Fig. 16. Reflow soldering footprint for CFP5 (SOD128)



**Fig. 17. Wave soldering footprint for CFP5 (SOD128)**

## 14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
ES2DP v.2	20170825	Product data sheet	-	ES2DP v.1
Modifications:	<ul style="list-style-type: none"><li>• Features and benefits: Updated</li><li>• Characteristics: Fig. 8 corrected</li></ul>			
ES2DP v.1	20170703	Product data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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